

*Exceptional service in the national interest*



# Micron-scale Reactive Atomistic Simulation of Void Collapse and Hotspot Growth in PETN

**Ray Shan, Ryan Wixom, Aidan Thompson**  
Sandia National Laboratories, New Mexico

American Physical Society March 2015 Meeting  
San Antonio, TX

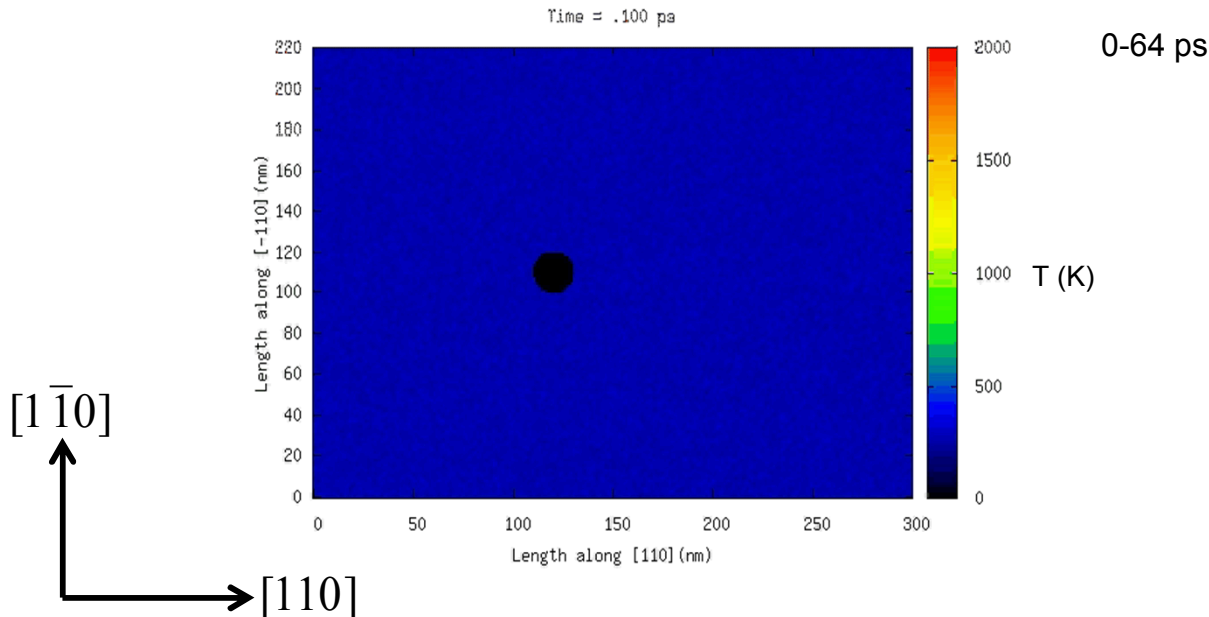
# Introduction

- Material defects and heterogeneities such as dislocations, grain boundaries, entrained gas, and porosity play key roles in the shock-induced initiation of detonation in energetic materials.
- Previously, we have performed a [LAMMPS/ReaxFF](#) NEMD shock simulation of a PETN crystal containing a [20 nm cylindrical void](#). We observed void collapse-induced [hot spot formation](#) and an [exothermic reaction zone](#).
  - Size:  $0.3\ \mu\text{m} \times 0.2\ \mu\text{m} \times 1.3\ \text{nm}$ ; 8.5 million atoms
  - Impact velocity: 1.25 km/s ( $U_s = 4.64\ \text{km/s}$ ,  $P = 2.5\ \text{GPa}$ )

# Introduction

- Material defects and heterogeneities such as dislocations, grain boundaries, entrained gas, and porosity play key roles in the shock-induced initiation of detonation in energetic materials.
- Previously, we have performed a **LAMMPS/ReaxFF** NEMD shock simulation of a PETN crystal containing a **20 nm cylindrical void**. We observed void collapse-induced **hot spot formation** and an **exothermic reaction zone**.
  - Size:  $0.3\ \mu\text{m} \times 0.2\ \mu\text{m} \times 1.3\ \text{nm}$ ; 8.5 million atoms
  - Impact velocity: 1.25 km/s ( $U_s = 4.64\ \text{km/s}$ ,  $P = 2.5\ \text{GPa}$ )

- **APS SCCM:** T.-R. Shan, A. P. Thompson, J. Phys.: Conf. Ser. 500, 172009 (2014)
- **IDS:** T.-R. Shan, A. P. Thompson, Proc. 15<sup>th</sup> International Detonation Symposium, Accepted for publication (2014)

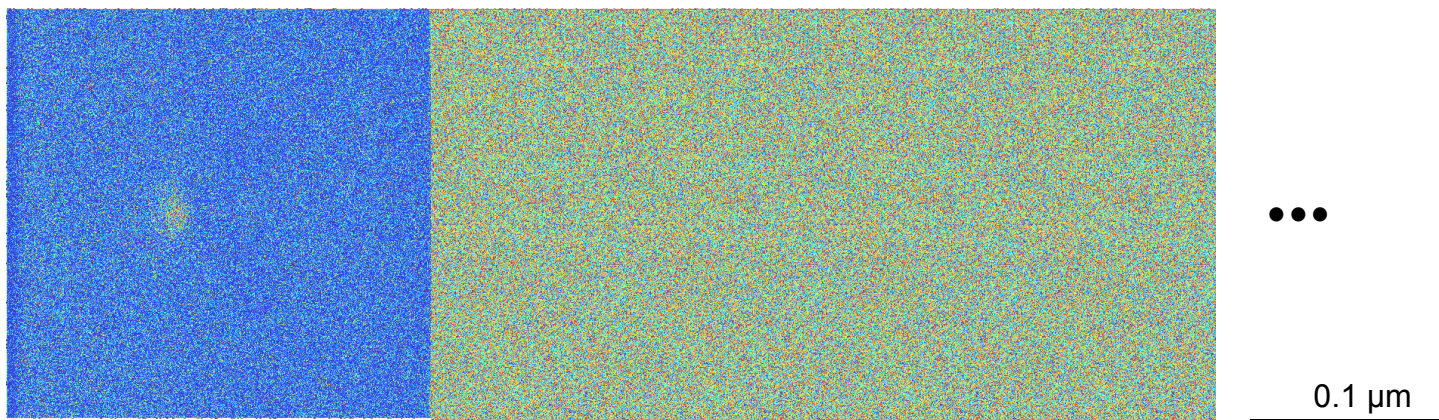


**Formation of hot spot observed, but**

- **Is it growing?**
- **Is it leading to detonation?**

# Computational setup

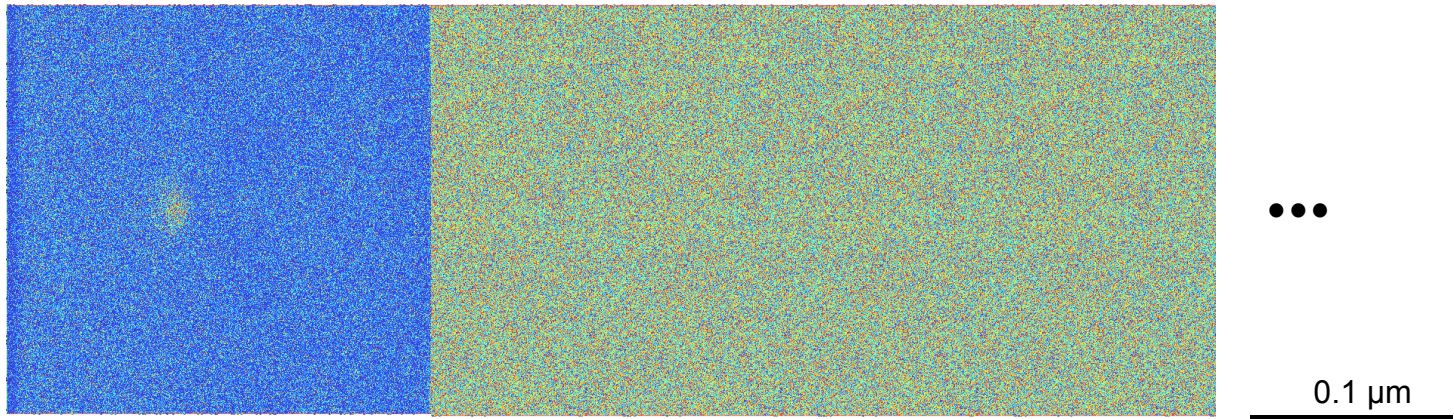
- Continue shock simulation after shockwave almost reached free surface
  - Conventional way is to add more uncompressed material



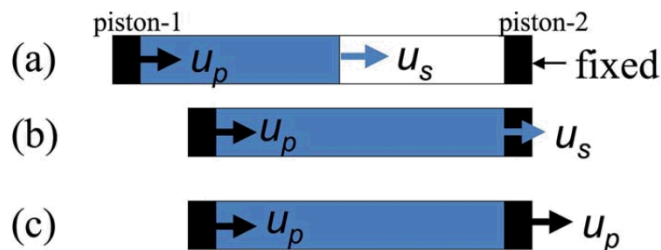
- Disadvantage: adds significant amount of computational expense

# Computational setup

- Continue shock simulation after shockwave almost reached free surface
  - Conventional way is to add more uncompressed material



- Disadvantage: adds significant amount of computational expense
- We utilize the “shock-front absorbing boundary condition (ABC)”

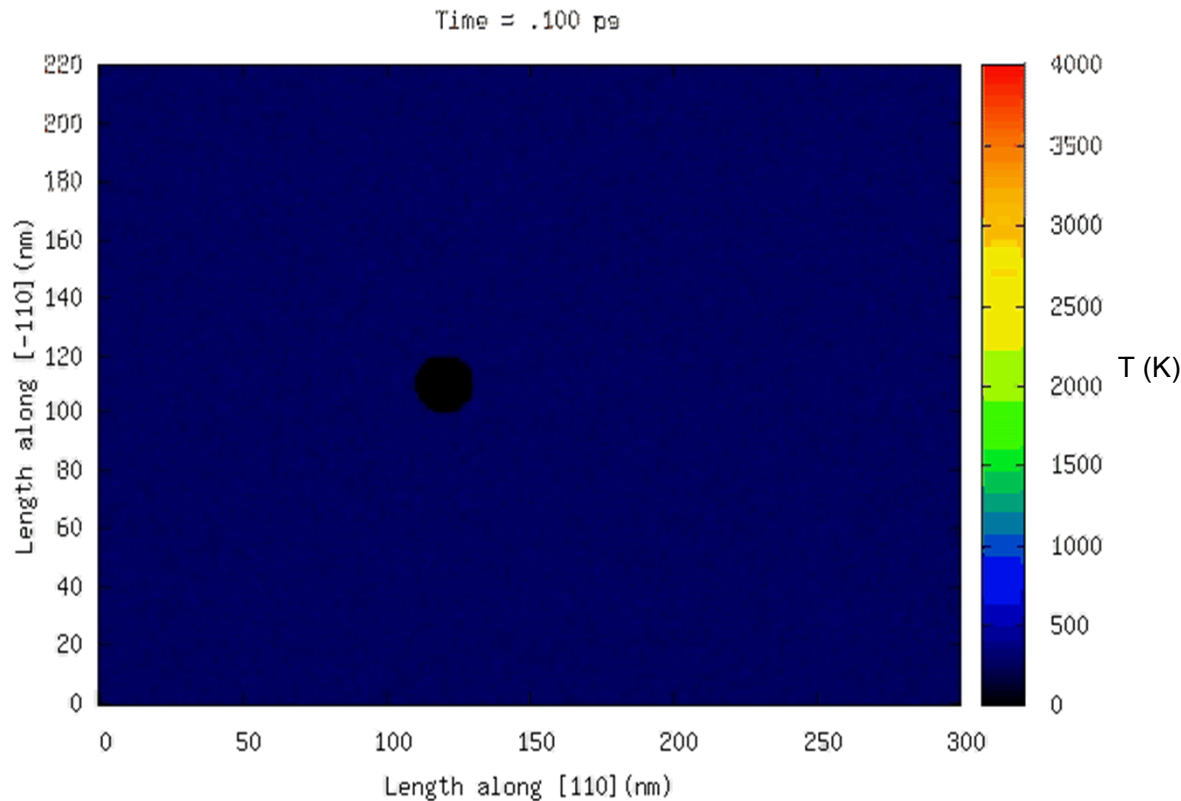


A. V. Bolesta, L. Zheng, D. L. Thompson, and T. D. Sewell, *Phys. Rev. B* 76, 224108 (2007).

**Objective: To observe hotspot growth and identify growth mechanism**

# Results: hot spot growth

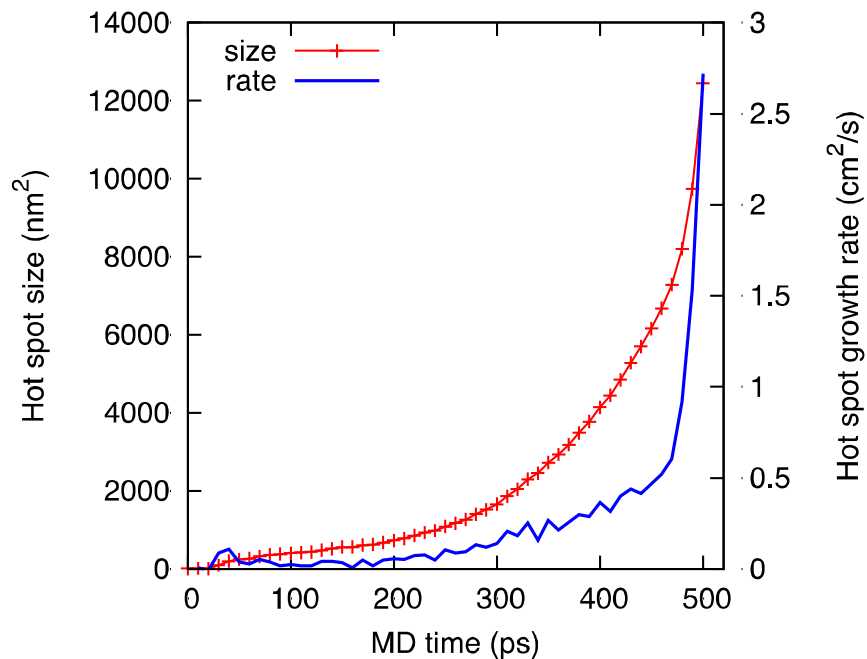
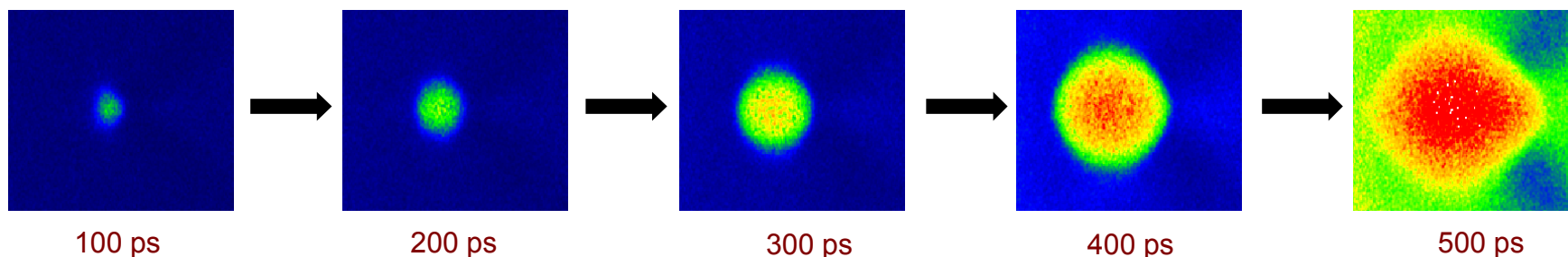
- Normal NEMD shock runs from 0 – 64 ps
  - Observed hotspot formation due to void collapse
- Shock-front ABC runs from 64 – 500 ps:
  - Observed hot spot growth due to coupling to exothermic chemical reactions



$H_2O$

$N_2$

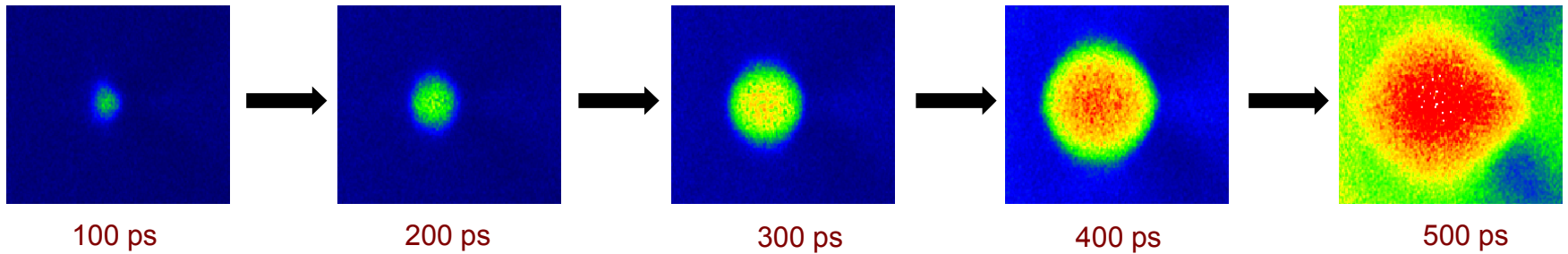
# Results: hot spot growth



Hot spot growth      Strong coupling      Exothermic chemical reactions



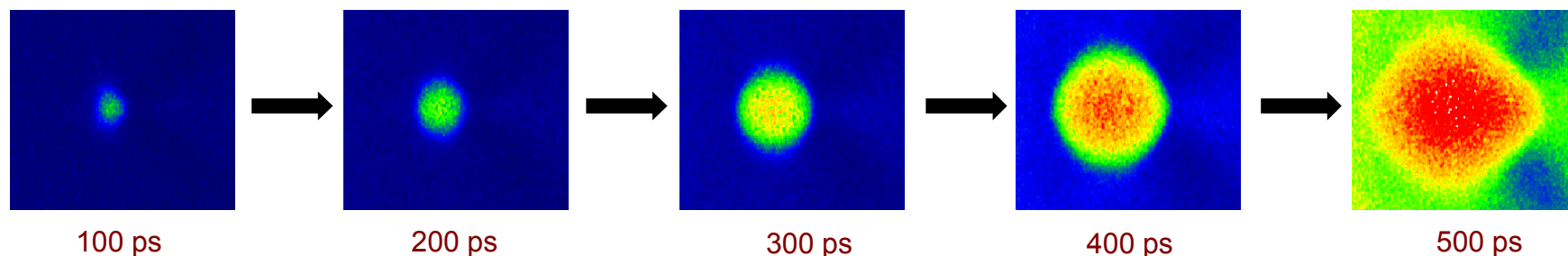
# Results: hot spot morphology



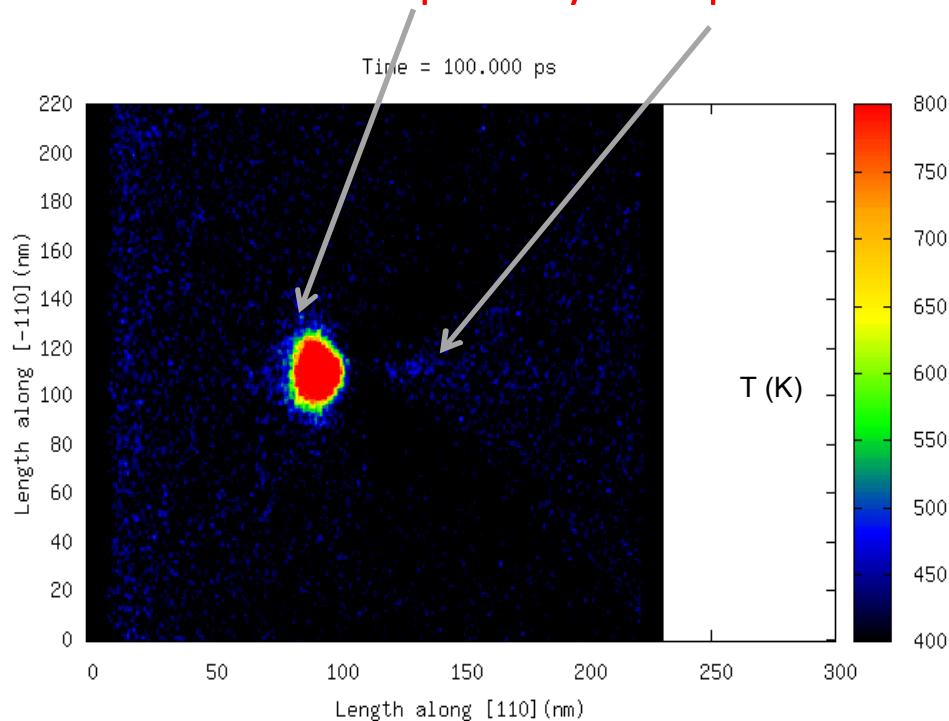
- Asymmetry developed after 400 ps. How?



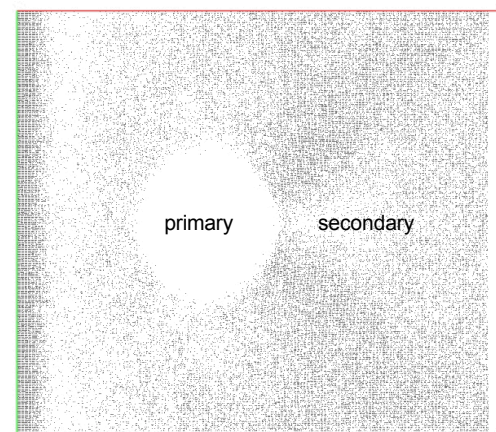
# Results: hot spot morphology



- Asymmetry developed after 400 ps. How?
- Due to interaction between **primary hot spot** and **secondary hot zone**.

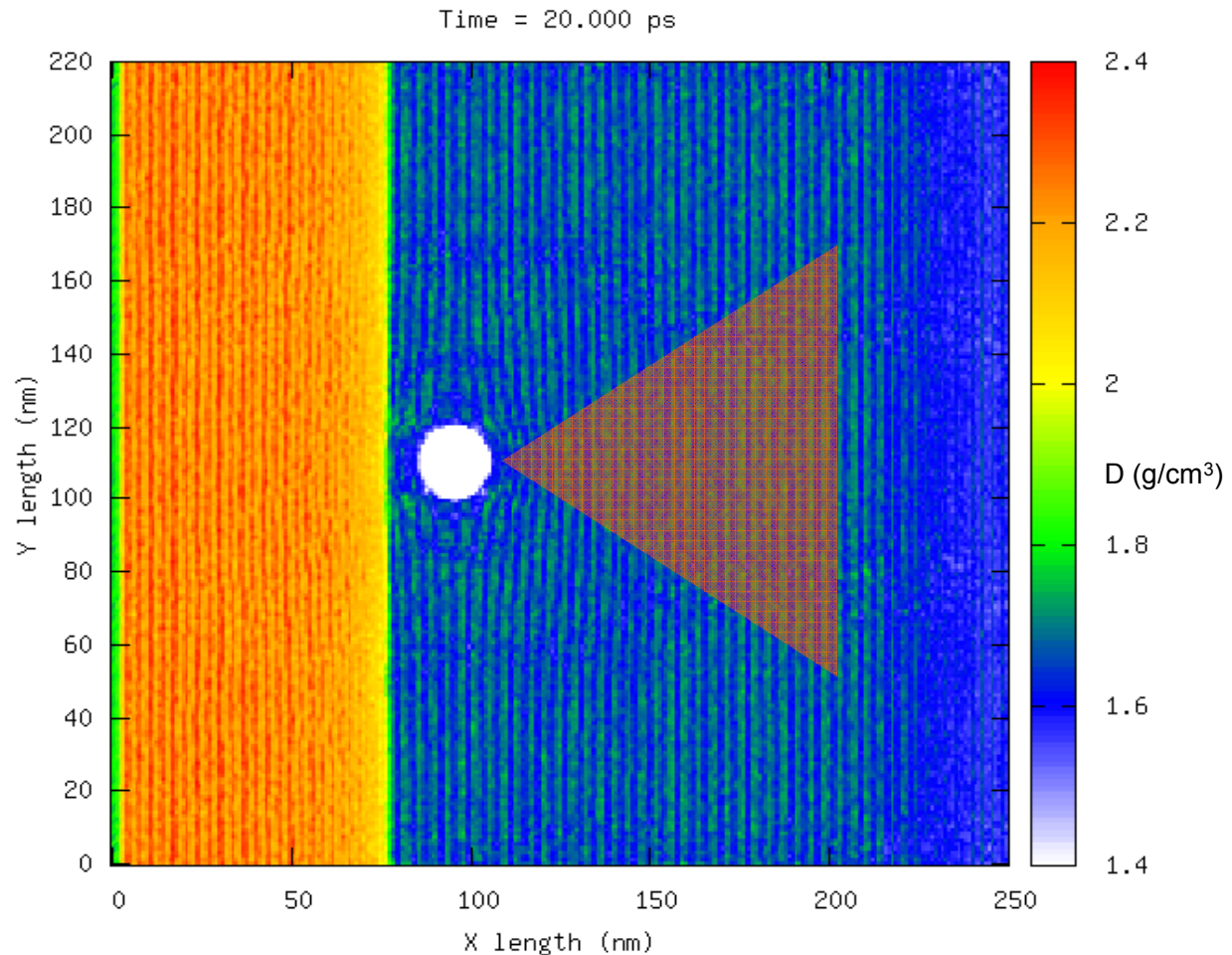


PETN @ 375 ps



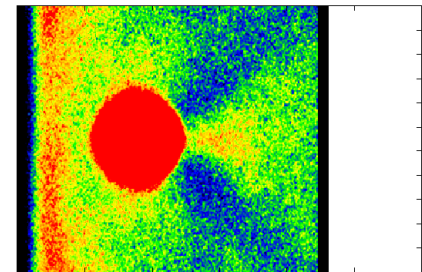
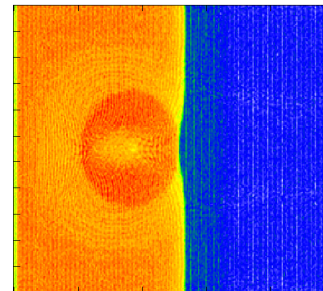
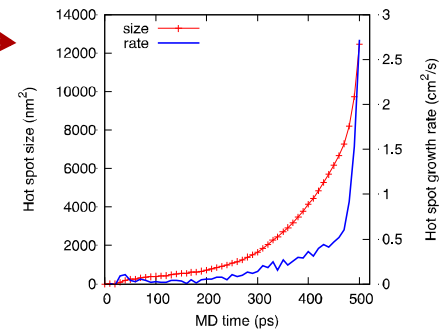
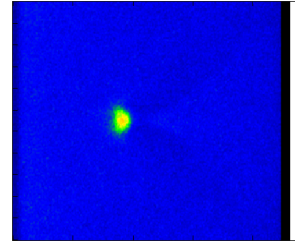
# Formation of secondary hot zone

- Due to secondary shock wave
  - Which occurs after void upstream/downstream collision
  - Forms a secondary hot zone as it fans out radially into uncompressed material



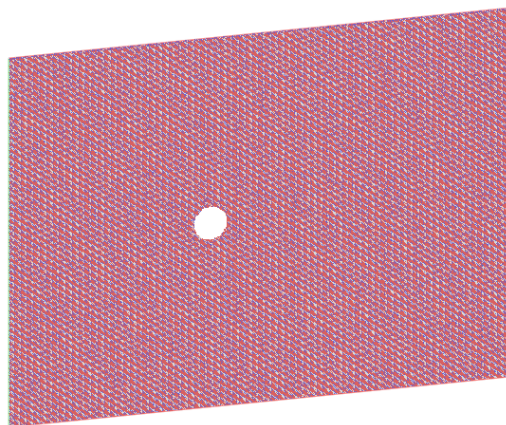
# Conclusions

- Performed NEMD shock simulation of a  $0.3 \times 0.2 \times 0.0013 \mu\text{m}^3$  PETN crystal containing a 20 nm cylindrical void
  - Observed void collapse-induced hot spot formation
- Obtained an exponential growing hot spot
  - Hot spot growth coupled to exothermic chemical reactions
  - Asymmetry developed due to interaction between the primary hot spot and a secondary hot zone
- Secondary hot zone resulted from secondary shock wave after collision between upstream void fragments and downstream void surface



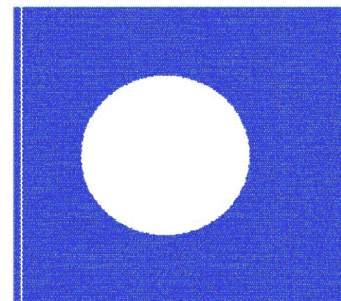
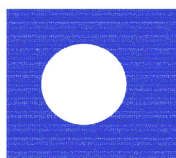
# Ongoing work

PETN  
20 nm void



0.1 μm

HNS  
50 & 100 nm void



Formation of  
hot spots

